

SPECIFICATION FOR

LCD MODULE

# MODULE NO: AFS320480TG-3.5-G010031 REVISION NO: 00

Customer's Approval:		

	SIGNATURE	DATE
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CHECKED BY	Fr. Li	2011-8-19
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## **DOCUMENT REVISION HISTORY**

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00	Jun-08-2011	First Issue	lhm
01	Jul-29-2011	Changed "Dimensional Outline"	Fr.li
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# 1. Features & Mechanical Specifications

Item	Contents	Unit
	LCD	
LCD Type	TFT / Transmissive / Normally Black	
Viewing direction	Full viewing angle	
Backlight	White LED x 6 in Parallel	
Interface	8080-16bit parallel bus interface	
Driver IC	ILI9481	
Outline Dimension	54.48(W) × 84.71(H) × 1.95(T)	mm
Glass area (W×H×T)	53.36 × 76.84 / 81.64 × 0.3	mm
Active area (W×H)	48.96 × 73.44	mm
Number of Dots	320(RGB)×480	
Dot pitch (W×H)	0.153 × 0.153	mm
Pixel pitch (W×H)	0.051 × 0.153	mm
Operating Temperature	-20 ~ +70	°C
Storage temperature	-30 ∼ +80	$^{\circ}\! \mathbb{C}$

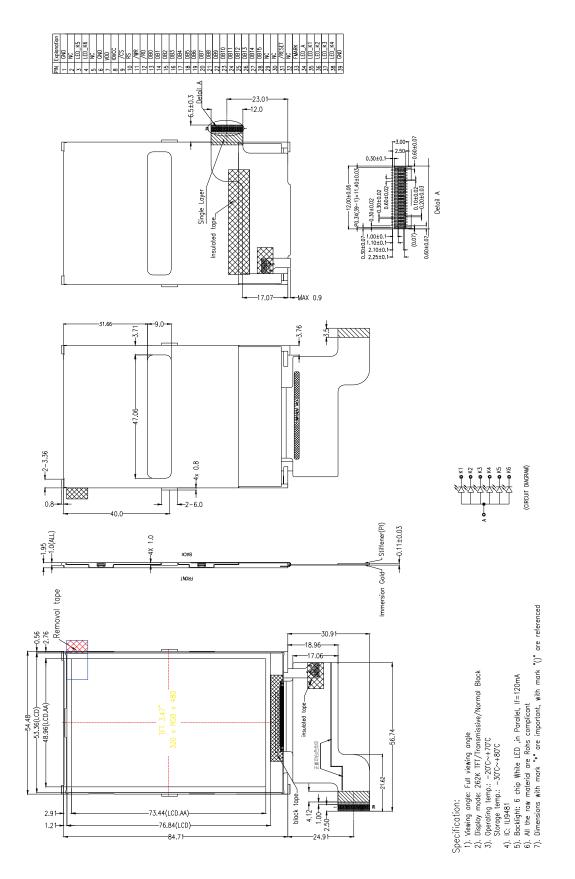


Figure 1. Dimensional outline

## 3. Block Diagram

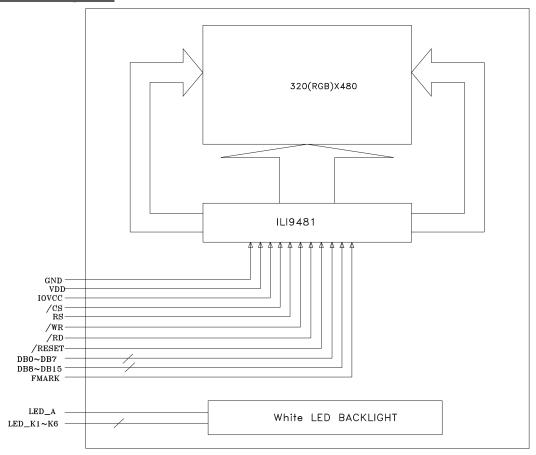


Figure 2. Block diagram

4. Pin Description

PIN No.	SYMBOL	Function
1	GND	Ground
2	NC	No Connection
3	LED_K5	LED5 Backlight Cathode
4	LED_K6	LED6 Backlight Cathode
5	NC	No Connection
6	GND	Ground
7	VDD	Analog Power Supply Voltage
8	IOVCC	I/O pin Power Supply Voltage
9	/CS	Chip select pin of serial interface
10	RS	Display data / command selection pin Low: command data High: display data
11	/WR	Write signal.
12	/RD	Read signal.
13~20	DB0~DB7	Data Bus
21~28	DB8~DB15	Data Bus
29~30	NC	No Connection
31	/RESET	System Reset Pin
32	NC	No Connection
33	FMARK	Tearing effect output pin
34	LED_A	LED Backlight Anode
35	LED_K1	LED1 Backlight Cathode
36	LED_K2	LED2 Backlight Cathode
37	LED_K3	LED3 Backlight Cathode
38	LED_K4	LED4 Backlight Cathode
39	GND	Ground

## **5. Absolute Maximum Ratings**

Item	Symbol	Rating	Unit
Power supply	VDD	-0.3 to +4 .6	V
Power supply	IOVCC	-0.3 to +4 .6	V
Operating Temperature range	Тор	-20 to +70	$^{\circ}$ C
Storage Temperature range	Tst	-30 to +80	$^{\circ}\mathbb{C}$

### **6. Electrical Characteristics**

#### **DC** Characteristics

Item	Symbol	Min.	Type.	Max.	Unit
Analog Power Supply Voltage	VDD	2.5	2.8	3.3	V
I/O pin Power Supply Voltage	IOVCC	1.65	2.8	3.3	V

## 7. Backlight Characteristics

White LED  $\times$  6 in Parallel

 $(Ta = 25^{\circ}C)$ 

Item	Symbol	Condition	Min	Тур	Max	Unit
Forward Voltage	VF	IF=120mA	-	3.2	-	V
Uniformity	△Bp	-	80	-	-	%
Luminance for LCD	Lv	IF=120mA	4500	1	-	cd/m <sup>2</sup>

### **8. Electro-Optical Characteristics**

lter	ltem		Conditions	S	Specifications			Note	
itei	"	Symbol	Conditions	Min.	Тур.	Max.	Unit	14016	
Transmi	ttance	Т%	Viewing normal	-	5.0	•	%	All left side data are based as CMO's	
Contrast	t Ratio	CR	angle	-	500	-		All left side data are based on CMO's following condition –	
Respons (by Qu		T <sub>R</sub> +T <sub>F</sub>	$\theta_X = \theta_Y$ =0°	-	30	-	ms	ms	1.CG : NTSC 70% (CIE1931)
	Hor.	$\theta_{X+}$		-	80	-			2.LC : VA LC 3.Light Source : CMO LED BLU
Viewing	noi.	$\theta_{X}$ .	Center	-	80		ala a	4.Film : Circular polarizer	
Angle	Ver.	$\theta_{Y+}$	CR>10	-	80	٠	deg.	5.Machine : DMS 803	
	ver.	$\theta_{Y}$ .		-	80			6.LC driving voltage: 5V	
	Red	X <sub>R</sub>		0.631	0.661	0.691			
	rea	YR	] [	0.292	0.322	0.352			
	Green	$X_{G}$	Viewing	0.247	0.277	0.307			
CF only	Green	$Y_G$	normal angle	0.547	0.577	0.607		Under C light	
Chromaticity	Chromaticity Blue	X <sub>B</sub>	$\theta_X = \theta_Y$	0.106	0.136	0.166		Orlow O light	
		YB	=0°	0.073	0.103	0.133			
	White	Xw	] [	0.260	0.290	0.320			
	VVIIILE	Yw		0.291	0.321	0.351			

<sup>\*</sup>Note (1) Definition of Contrast Ratio (CR):

The contrast ratio can be calculated by the following expression.

Contrast Ratio (CR) = L63 / L0

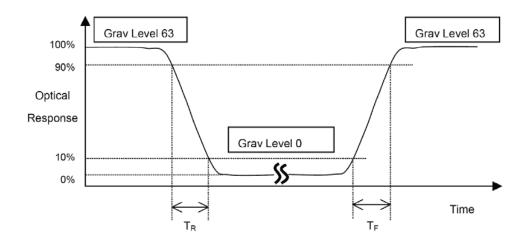
L63: Luminance of gray level 63

L0: Luminance of gray level 0

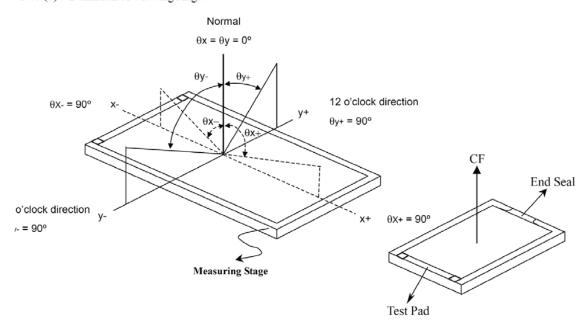
CR = CR(5)

CR (X) is corresponding to the Contrast Ratio of the point X at Figure in Note (5).

<sup>\*</sup>Note (2) Definition of Response Time (TR, TF):



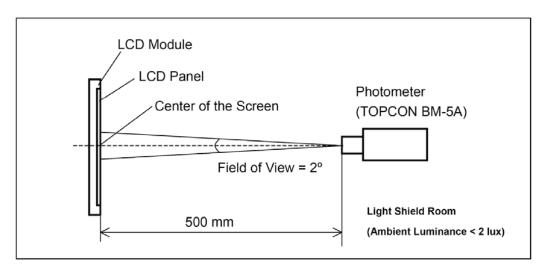
#### \*Note(3) Definition of Viewing Angle



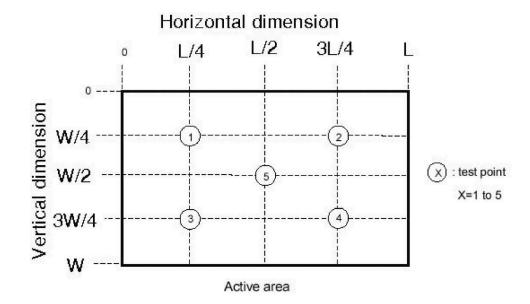
\*\*\* The above "Viewing Angle" is the measuring position with Largest Contrast Ratio; not for good image quality. View Direction for good image quality is Free. Module maker can increase the "Viewing Angle" by applying Wide View Film.

#### \*Note (4) Measurement Set-Up:

The LCD module should be stabilized at a given temperature for 20 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting Backlight for 20 minutes in a windless room.



\*Note (5)

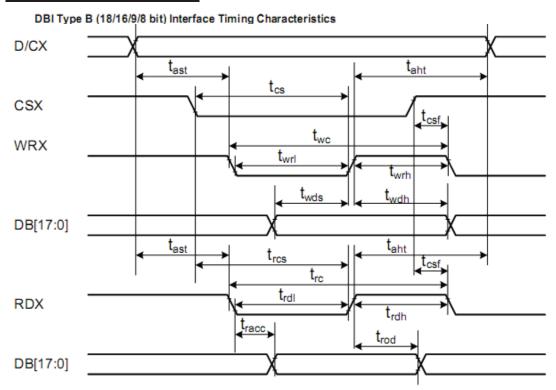


# 9. Instruction Description

Operational Code (Hex)	Command	Command(C) /Read(R) /Write(W)	Number Of Parameter	MIPI DCS Type1 Requirement	ILI9418 Implementation
00h	nop	С	0	Yes	Yes
01h	soft reset	С	0	Yes	Yes
06h	get red channel	R	1	No	No
07h	get_green_channel	R	1	No	No
08h	get blue channel	R	1	No	No
0Ah	get_power_mode	R	1	Yes	Yes
0Bh	get address mode	R	1	Yes (Bit[7:0])	Yes (Bit[7:3]), Only)
0Ch	get_pixel_format	R	1	Yes	Yes
0Dh	get display mode	R	1	Yes	Yes
0Eh	get_signal_mode	R	1	Yes	Yes
0Fh	get_diagnostic _result	R	1	Bit7/6: Yes Bit5/4: Optional	Yes (Bit7/6 Only)
10h	enter_sleep_mode	С	0	Yes	Yes
11h	exit_sleep_mode	С	0	Yes	Yes
12h	enter_partial_mode	С	0	Yes	Yes
13h	enter normal mode	С	0	Yes	Yes
20h	exit_invert_mode	С	0	Yes	Yes
21h	enter_invert_mode	С	0	Yes	Yes
26h	set gamma curve	W	1	Yes	No
28h	set display off	С	0	Yes	Yes
29h	set_display_on	С	0	Yes	Yes
2Ah	set_column_address	W	4	Yes	Yes
2Bh	set_page_address	W	4	Yes	Yes
2Ch	write memory start	W	Variable	Yes	Yes
2Dh	wite LUT	W	Variable	Optional	No
2Eh	read_memory_start	R	Variable	Yes	Yes
30h	set partial area	W	4	Yes	Yes
33h	set_scroll_area	W	6	Yes	Yes
34h	set tear off	С	0	Yes	Yes
35h	set_tear_on	W	1	Yes	Yes
36h	set_address_mode	w	1	Yes (Bit7-0)	Yes (Bit[7:3], Bit[1:0] Only)
37h	set_scroll_start	W	2	Yes	Yes
38h	exit_idle_mode	С	0	Yes	Yes
39h	enter_idle_mode	С	0	Yes	Yes
3Ah	set_pixel_format	W	1	Yes	Yes
3Ch	write_memory _continue	W	Variable	Yes	Yes
3Eh	read_memory _continue	R	Variable	Yes	Yes
44h	set_tear_scanline	W	2	Yes	Yes
45h	get_scanline	R	2	Yes	Yes
A1h	read_DDB_start	R	5	Yes	Yes
A8h	read DDB continue	R	Variable	Yes	Yes

Operational Code (Hex)	Function	Command(C) Read(R)/Write(W)	Number Of Parameter
B0h	Command Access Protect	W/R	1
B1h	Low Power Mode Control	W/R	1
B3h	Frame Memory Access and Interface setting	W/R	5
B4h	Display Mode and Frame Memory Write Mode setting	W/R	1
BFh	Device code Read	R	4
C0h	Panel Driving Setting	W/R	7
C1h	Display Timing Setting for Normal Mode	W/R	3
C2h	Display Timing Setting for Partial Mode	W/R	3
C3h	Display Timing Setting for Idle Mode	W/R	3
C5h	Frame rate and Inversion Control	W/R	1
C6h	Interface Control	W/R	1
C8h	Gamma Setting	W/R	12
D0h	Power Setting	W/R	3
D1h	VCOM Control	W/R	3
D2h	Power Setting for Normal Mode	W/R	2
D3h	Power Setting for Partial Mode	W/R	2
D4h	Power Setting for Idle Mode	W/R	2
E0h	NV Memory Write	W/R	1
E1h	NV Memory Control	W/R	1
E2h	NV Memory Status	W/R	3
E3h	NV Memory Protection	W/R	2
B0∼FF Except above command	LSI TEST Registers	W/R	Variable

## 10. AC Characteristics



Signal	Symbo I	Parameter	min	max	Unit	Description
D/CX	tast	Address setup time	10	•	ns	
DICX	taht	Address hold time (Write/Read)	10	-	ns	
	tcs	Chip Select setup time (Write)	20	-	ns	
CSX	trcs	Chip Select setup time (Read)	20	-	ns	
	tcsf	Chip Select Wait time (Write/Read)	20	•	ns	
	twc	Write cycle	100	•	ns	
WRX	twrh	Write Control pulse H duration	30		ns	
	twrl	Write Control pulse L duration	25	-	ns	
	trc	Read cycle	450	•	ns	
RDX	trdh	Read Control pulse H duration	250	•	ns	
	trdl	Read Control pulse L duration	170		ns	
DB[17:0], DB[15:0], DB[8:0], DB[7:0]	twds	Write data setup time	15		ns	
	twdh	Write data hold time	25	•	ns	For maximum CL=30pF
	tracc	Read access time	10	340	ns	For minimum CL=8pF
	trod	Read output disable time	10		ns	

Note: Logic high and low levels are specified as 30% and 70% of IOVCC for Input signals.

Note: Ta = -30 to 70 °C, IOVCC=1.65V to 3.3V, VCI=2.5V to 3.3V, GND=0V

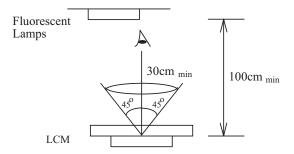
### **11.Quality Specifications**

### All The raw material are Rohs complicant.

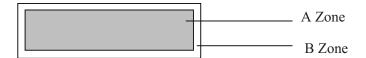
### 11.1 Standard of the product appearance test

Manner of appearance test: The inspection should be performed in using  $20W \times 2$  fluorescent lamps. Distance between LCM and fluorescent lamps should be 100 cm or more. Distance between LCM and inspector eyes should be 30 cm or more.

Viewing direction for inspection is 45° from vertical against LCM.



Definition of zone:



A Zone: viewing area

B Zone: outside viewing area

### 11.2 Specification of quality assurance

AQL inspection standard

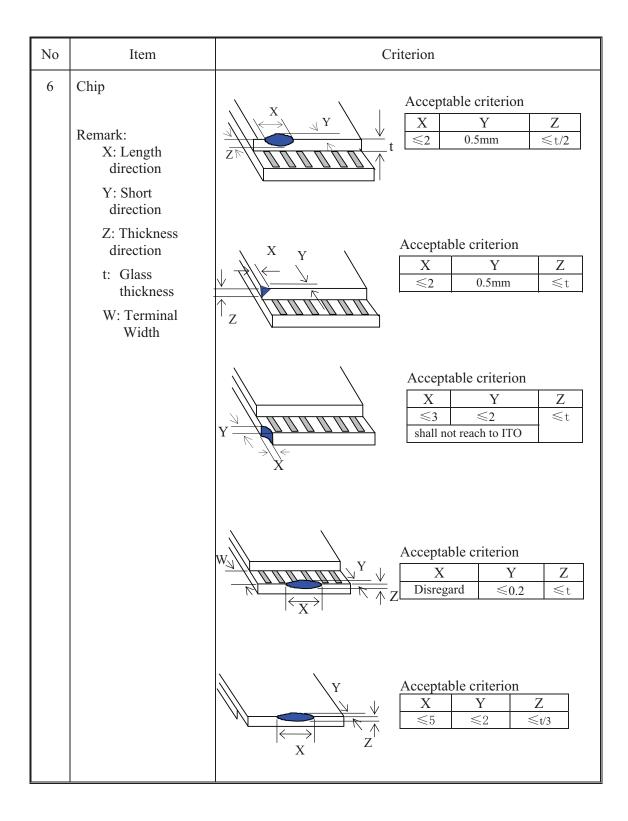
Sampling method: MIL-STD-105E, Level II, single sampling

## **Defect classification (Note: \* is not including)**

Classify		Item	Note	AQL
Major	Display state	Short or open circuit		0.65
		LC leakage		
		Flickering	1	
		No display		
		Wrong viewing direction		
		Contrast defect (dim, ghost)	2	
		Back-light	1,8	
	Non-display	Flat cable or pin reverse	10	
		Wrong or missing component	11	
Minor	Display state	Background color deviation	2	1.0
		Black spot and dust	3	
		Line defect, Scratch	4	
		Rainbow	5	
		Chip	6	
		Pin hole	7	
	Polarizer	Protruded	12	
		Bubble and foreign material	3	
	Soldering	Poor connection	9	
	Wire	Poor connection	10	
	TAB	Position, Bonding strength	13	

### Note on defect classification

No.	Item	Criterion			
1	Short or open circuit	Not allow			
	LC leakage				
	Flickering				
	No display				
	Wrong viewing direction				
	Wrong Back-light				
2	Contrast defect	Refer to approval sample			
	Background color deviation				
3	Point defect, Black spot, dust (including Polarizer)	$\bigcirc \bigcirc \uparrow Y$		Point Size	Acceptable Qty.  Disregard
	(menuming 1 enumer)	A	-	φ <u>&lt;</u> 0.10 0.10<φ≤0.20	3
				0.20<φ≤0.25	2
	$\phi = (X+Y)/2$		-	0.25<φ≤0.30	1
				φ>0.30	0
		Unit: mm			
4	Line defect,	w			
	Scratch			Line	Acceptable Qty.
	Scratch	⇔  T	L	W 0.02≥W	Disregard
		L	4.0≥L	$0.02 \ge W$ $0.03 \ge W > 0.02$	
			2.0≥L	$0.05 \ge W > 0.02$	2
			1.0≥L	0.1>W>0.05	1
				0.1 <w< td=""><td>Applied as point defect</td></w<>	Applied as point defect
			Ţ	Jnit: mm	
5	Rainbow	Not more than two color changes across the viewing area.			



No.	Item	Criterion		
7	Segment pattern $W = \text{Segment width}$ $\phi = (X+Y)/2$	(1) Pin hole $\phi < 0.10 \text{mm is acceptable.}$ $Y = \begin{array}{c ccccc} X & & & & \\ \hline & & & & \\ \hline & & & & \\ \hline & & & &$		
8	Back-light	<ul><li>(1) The color of backlight should correspond its specification.</li><li>(2) Not allow flickering</li></ul>		
9	Soldering	(1) Not allow heavy dirty and solder ball on PCB.  (The size of dirty refer to point and dust defect)  (2) Over 50% of lead should be soldered on Land.  Lead  Land  50% lead		
10	Wire	<ol> <li>(1) Copper wire should not be rusted</li> <li>(2) Not allow crack on copper wire connection.</li> <li>(3) Not allow reversing the position of the flat cable.</li> <li>(4) Not allow exposed copper wire inside the flat cable.</li> </ol>		
11*	PCB	(1) Not allow screw rust or damage. (2) Not allow missing or wrong putting of component.		

No	Item	Criterion			
12	Protruded W: Terminal Width	Acceptable criteria: $Y \le 0.4$			
13	TAB	1. Position  W W1 H H TAB  W1 H 173W H 1≤1/3W H 1≤1/3H			
		2 FPC bonding strength test  F  FPC  P (=F/FPC bonding width) ≥650gf/cm ,(speed rate: 1mm/min) 5pcs per SOA (shipment)			
14	Total no. of acceptable Defect	A. Zone  Maximum 2 minor non-conformities per one unit.  Defect distance: each point to be separated over 10mm  B. Zone  It is acceptable when it is no trouble for quality and assembly in customer's end product.			

### 11.3 Reliability of LCM

Reliability test condition:

Item	Condition	Time (hrs)	Assessment
High temp. Storage	60°C	48	
High temp. Operating	50°C	48	
Low temp. Storage	-10°C	48	No abnormalities
Low temp. Operating	0°C	48	in functions
Humidity	40°C/ 90%RH	48	and appearance
Temp. Cycle	-10°C ← 25°C →60°C	10cycles	
	$(60 \min \leftarrow 5 \min \rightarrow 60 \min)$		

Recovery time should be 24 hours minimum. Moreover, functions, performance and appearance shall be free from remarkable deterioration within 50,000 hours under ordinary operating and storage conditions room temperature ( $20\pm8^{\circ}$ C), normal humidity (below 65% RH), and in the area not exposed to direct sun light.

#### 11.4 Precaution for using LCD/LCM

LCD/LCM is assembled and adjusted with a high degree of precision. Do not attempt to make any alteration or modification. The followings should be noted.

#### **General Precautions:**

- 1. LCD panel is made of glass. Avoid excessive mechanical shock or applying strong pressure onto the surface of display area.
- 2. The polarizer used on the display surface is easily scratched and damaged. Extreme care should be taken when handling. To clean dust or dirt off the display surface, wipe gently with cotton, or other soft material soaked with isoproply alcohol, ethyl alcohol or trichlorotriflorothane, do not use water, ketone or aromatics and never scrub hard.
- 3. Do not tamper in any way with the tabs on the metal frame.
- 4. Do not made any modification on the PCB without consulting Orient Display.
- 5. When mounting a LCM, make sure that the PCB is not under any stress such as bending or twisting. Elastomer contacts are very delicate and missing pixels could result from slight dislocation of any of the elements.
- 6. Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing pixels and also cause rainbow on the display.
- 7. Be careful not to touch or swallow liquid crystal that might leak from a damaged cell. Any liquid crystal adheres to skin or clothes, wash it off immediately with soap and water.

#### **Static Electricity Precautions:**

- 1. CMOS-LSI is used for the module circuit; therefore operators should be grounded whenever he/she comes into contact with the module.
- 2. Do not touch any of the conductive parts such as the LSI pads; the copper leads on the PCB and the interface terminals with any parts of the human body.
- 3. Do not touch the connection terminals of the display with bare hand; it will cause disconnection or defective insulation of terminals.
- 4. The modules should be kept in anti-static bags or other containers resistant to static for storage.
- 5. Only properly grounded soldering irons should be used.
- 6. If an electric screwdriver is used, it should be grounded and shielded to prevent sparks.
- 7. The normal static prevention measures should be observed for work clothes and working benches.
- 8. Since dry air is inductive to static, a relative humidity of 50-60% is recommended.

#### **Soldering Precautions:**

- 1. Soldering should be performed only on the I/O terminals.
- 2. Use soldering irons with proper grounding and no leakage.
- 3. Soldering temperature: 280°C+10°C
- 4. Soldering time: 3 to 4 second.
- 5. Use eutectic solder with resin flux filling.
- 6. If flux is used, the LCD surface should be protected to avoid spattering flux.
- 7. Flux residue should be removed.

#### **Operation Precautions:**

- 1. The viewing angle can be adjusted by varying the LCD driving voltage Vo.
- 2. Since applied DC voltage causes electro-chemical reactions, which deteriorate the display, the applied pulse waveform should be a symmetric waveform such that no DC component remains. Be sure to use the specified operating voltage.
- 3. Driving voltage should be kept within specified range; excess voltage will shorten display life.
- 4. Response time increases with decrease in temperature.
- 5. Display color may be affected at temperatures above its operational range.
- 6. Keep the temperature within the specified range usage and storage. Excessive temperature and humidity could cause polarization degradation, polarizer peel-off or generate bubbles.
- 7. For long-term storage over 40°C is required, the relative humidity should be kept below 60%, and avoid direct sunlight.

#### **Limited Warranty**

Orient DisplayLCDs and modules are not consumer products, but may be incorporated by Orient Display's customers into consumer products or components thereof, Orient Display does not warrant that its LCDs and components are fit for any such particular purpose.

- 1. The liability of Orient Display is limited to repair or replacement on the terms set forth below. Orient Display will not be responsible for any subsequent or consequential events or injury or damage to any personnel or user including third party personnel and/or user. Unless otherwise agreed in writing between Orient Display and the customer, Orient Display will only replace or repair any of its LCD which is found defective electrically or visually when inspected in accordance with Orient Display general LCD inspection standard. (Copies available on request)
- 2. No warranty can be granted if any of the precautions state in handling liquid crystal display above has been disregarded. Broken glass, scratches on polarizer mechanical damages as well as defects that are caused accelerated environment tests are excluded from warranty.
- 3. In returning the LCD/LCM, they must be properlypackaged; there should be detailed description of the failures or defect.